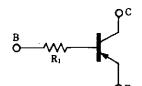


# COMPOUND TRANSISTOR BN1A4Z

# on-chip resistor PNP silicon epitaxial transistor For mid-speed switching

#### **FEATURES**

 On-chip bias resistor (R<sub>1</sub> = 10 kΩ)



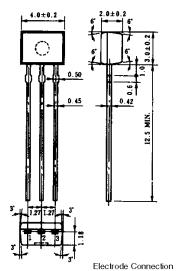
· Complementary transistor with BA1A3Q

### ABSOLUTE MAXIMUM RATINGS (Ta = 25°C)

Parameter	Symbol	Ratings	Unit
Collector to base voltage	Vcво	-60	V
Collector to emitter voltage	Vceo	<b>–50</b>	V
Emitter to base voltage	V <sub>EBO</sub>	<b>-</b> 5	V
Collector current (DC)	Ic(DC)	-100	mA
Collector current (Pulse)	Ic(pulse) *	-200	mA
Total power dissipation	Рт	250	mW
Junction temperature	Tj	150	°C
Storage temperature	T <sub>stg</sub>	-55 to +150	°C

<sup>\*</sup> PW  $\leq$  10 ms, duty cycle  $\leq$  50 %

#### PACKAGE DRAWING (UNIT: mm)



ectrode Connection

- 1. Emitter
- Collector
   Base

## **ELECTRICAL CHARACTERISTICS (Ta = 25°C)**

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Collector cutoff current	Ісво	$V_{CB} = -50 \text{ V}, I_E = 0$			100	nA
DC current gain	h <sub>FE1</sub> **	$V_{CE} = -5.0 \text{ V}, \text{ Ic} = -5.0 \text{ mA}$	135	190	600	-
DC current gain	h <sub>FE2</sub> **	$V_{CE} = -5.0 \text{ V}, \text{ Ic} = -50 \text{ mA}$	100	170		-
Collector saturation voltage	VCE(sat) **	$I_{\text{C}} = -5.0 \text{ mA}, I_{\text{B}} = -0.25 \text{ mA}$		-0.07	-0.2	V
Low level input voltage	VIL **	$V_{CE} = -5.0 \text{ V}, \text{ Ic} = -100 \ \mu\text{A}$		-0.57	-0.5	V
High level input voltage	V <sub>IH</sub> **	$V_{CE} = -0.2 \text{ V}, \text{ Ic} = -5.0 \text{ mA}$	-2.0	-0.9		V
Input resistance	R <sub>1</sub>		7.0	10	13.0	kΩ
Turn-on time	ton	$V$ cc = $-5.0$ V, $R$ L = $1.0$ k $\Omega$			0.2	μs
Storage time	<b>t</b> stg	$V_1 = -5.0 \text{ V}, \text{ PW} = 2.0 \ \mu\text{s}$			5.0	μs
Turn-off time	toff	duty cycle≤2 %			6.0	μs

<sup>\*\*</sup> Pulse test PW  $\leq$  350  $\mu$ s, duty cycle  $\leq$  2 %

#### **hfe CLASSIFICATION**

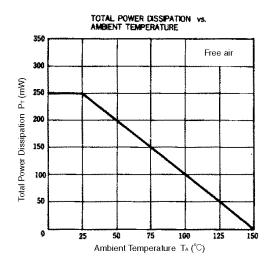
Marking	Q	Р	К
h <sub>FE1</sub>	135 to 270	200 to 400	300 to 600

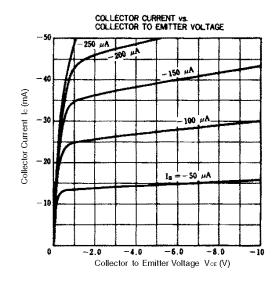
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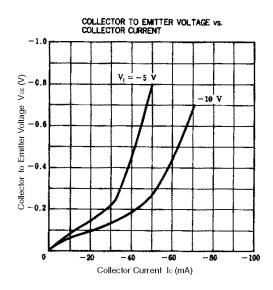
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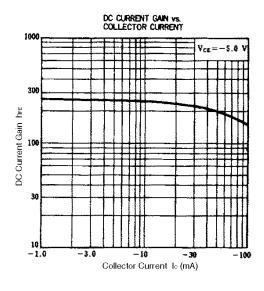


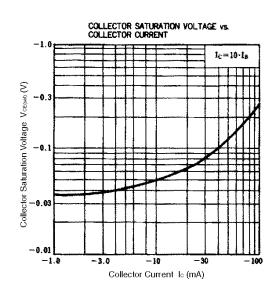
# TYPICAL CHARACTERISTICS (Ta = 25°C)

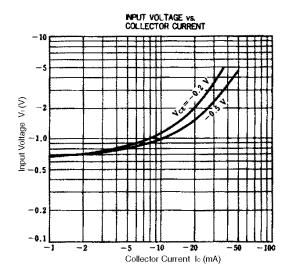


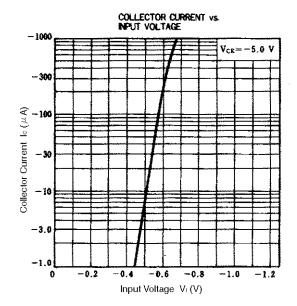


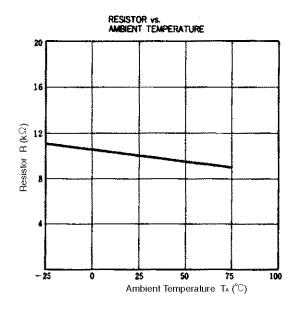












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